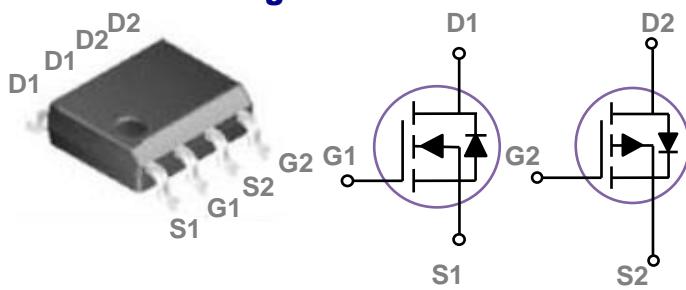


General Description

These N+P dual Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

SOP-8L Pin Configuration



BVDSS	RDSON	ID
100V	155mΩ	2.1A
-100V	290mΩ	-1.7A

Features

- Fast switching
- Green Device Available
- Suit for 4.5V Gate Drive Applications

Applications

- DC Fan
- Motor Drive Applications
- Networking
- Half / Full Bridge Topology

Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating		Units
V_{DS}	Drain-Source Voltage	100	-100	V
V_{GS}	Gate-Source Voltage	± 20	± 20	V
I_D	Drain Current – Continuous ($T_A=25^\circ\text{C}$)	2.1	-1.7	A
	Drain Current – Continuous ($T_A=70^\circ\text{C}$)	1.7	-1.4	A
I_{DM}	Drain Current – Pulsed ¹	8.4	6.8	A
EAS	Single Pulse Avalanche Energy ²	2.5	6.1	mJ
IAS	Single Pulse Avalanche Current ²	7	11	A
P_D	Power Dissipation ($T_A=25^\circ\text{C}$)	1.47		W
	Power Dissipation – Derate above 25°C	0.011		W/ $^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150		$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 150		$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	---	85	$^\circ\text{C}/\text{W}$

N-CH Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise)
Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{D}}=250\mu\text{A}$	100	---	---	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	BV_{DSS} Temperature Coefficient	Reference to 25°C , $I_{\text{D}}=1\text{mA}$	---	0.09	---	$\text{V}/^\circ\text{C}$
I_{DSS}	Drain-Source Leakage Current	$V_{\text{DS}}=100\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=25^\circ\text{C}$	---	---	1	μA
		$V_{\text{DS}}=80\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=125^\circ\text{C}$	---	---	10	μA
I_{GSS}	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA

On Characteristics

$R_{\text{DS}(\text{ON})}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=10\text{V}$, $I_{\text{D}}=2\text{A}$	---	128	155	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}$, $I_{\text{D}}=1\text{A}$	---	132	170	$\text{m}\Omega$
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$, $I_{\text{D}}=250\mu\text{A}$	1.2	1.6	2.5	V
			---	-4.2	---	$\text{mV}/^\circ\text{C}$
g_{fs}	Forward Transconductance	$V_{\text{DS}}=10\text{V}$, $I_{\text{D}}=1\text{A}$	---	5	---	S

Dynamic and switching Characteristics

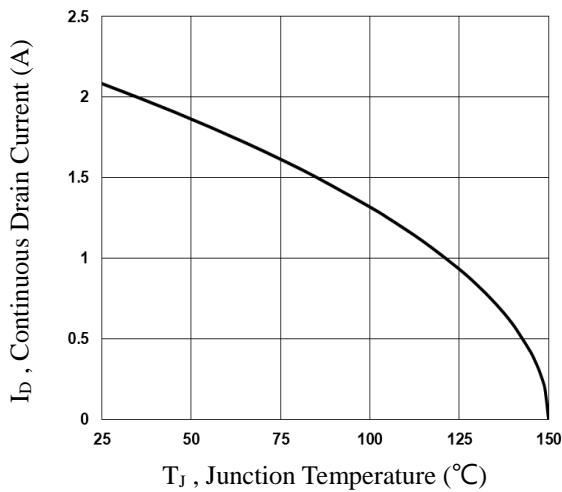
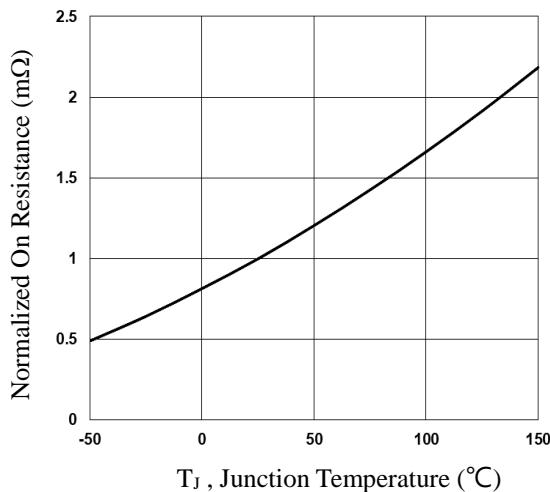
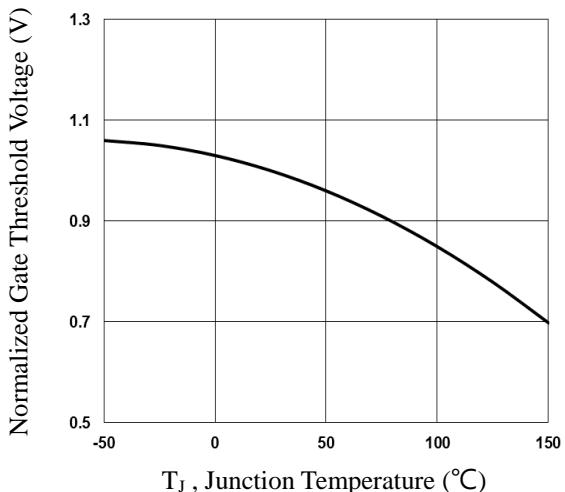
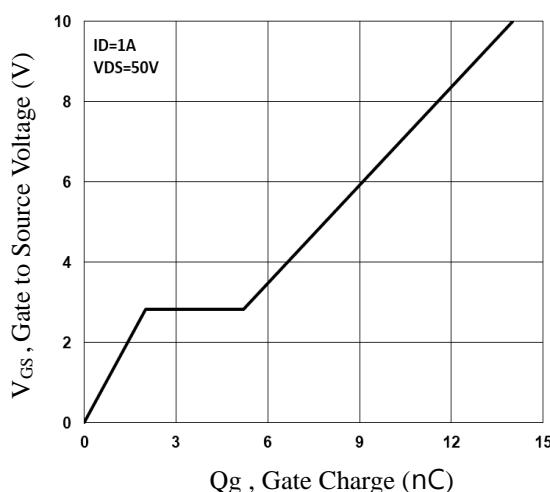
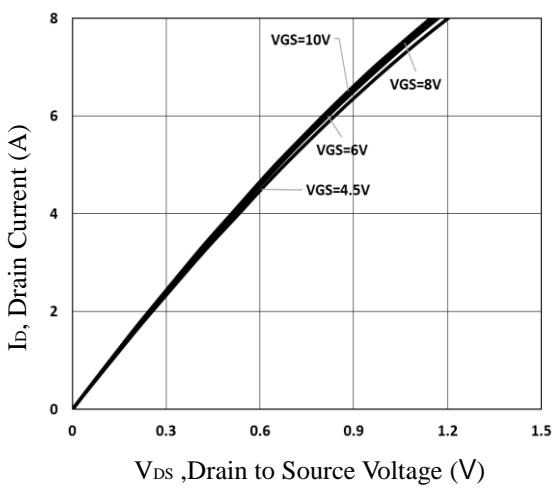
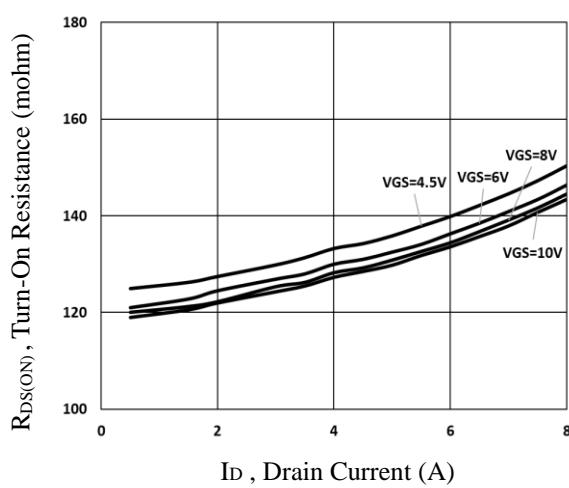
Q_g	Total Gate Charge ^{3, 4}	$V_{\text{DS}}=50\text{V}$, $V_{\text{GS}}=10\text{V}$, $I_{\text{D}}=1\text{A}$	---	14	28	nC
Q_{gs}	Gate-Source Charge ^{3, 4}		---	2	4	
Q_{gd}	Gate-Drain Charge ^{3, 4}		---	3.2	6.5	
$T_{\text{d}(\text{on})}$	Turn-On Delay Time ^{3, 4}	$V_{\text{DD}}=50\text{V}$, $V_{\text{GS}}=10\text{V}$, $R_{\text{G}}=6\Omega$ $I_{\text{D}}=1\text{A}$	---	7.8	15	ns
T_r	Rise Time ^{3, 4}		---	10.2	21	
$T_{\text{d}(\text{off})}$	Turn-Off Delay Time ^{3, 4}		---	17.4	35	
T_f	Fall Time ^{3, 4}		---	3.1	7	
C_{iss}	Input Capacitance	$V_{\text{DS}}=50\text{V}$, $V_{\text{GS}}=0\text{V}$, $F=1\text{MHz}$	---	1034	2070	pF
C_{oss}	Output Capacitance		---	29	58	
C_{rss}	Reverse Transfer Capacitance		---	20	40	
R_g	Gate resistance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, $F=1\text{MHz}$	---	1.48	3	Ω

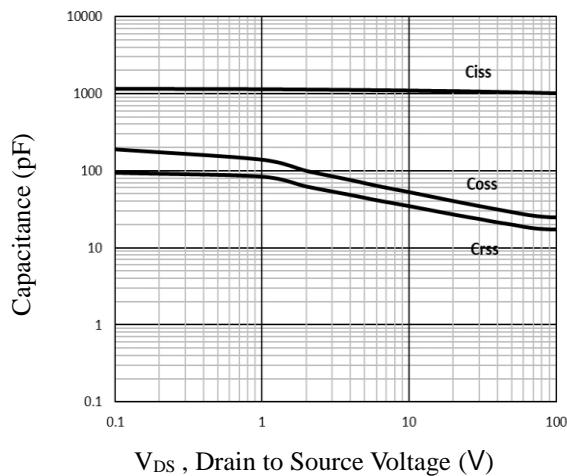
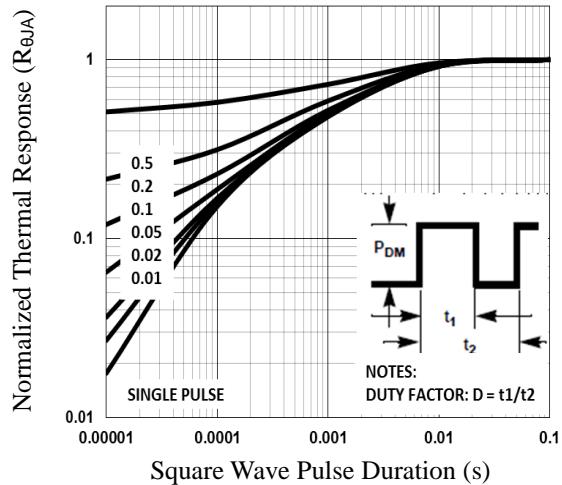
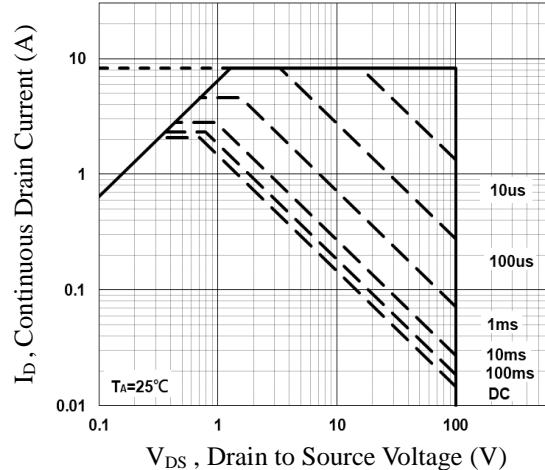
Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Continuous Source Current	$V_G=V_D=0\text{V}$, Force Current	---	---	2.1	A
I_{SM}	Pulsed Source Current		---	---	4.2	A
V_{SD}	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$, $I_{\text{S}}=1\text{A}$, $T_J=25^\circ\text{C}$	---	---	1	V

Note :

- Repetitive Rating : Pulsed width limited by maximum junction temperature.
- $V_{\text{DD}}=25\text{V}$, $V_{\text{GS}}=10\text{V}$, $L=0.1\text{mH}$, N-CH $I_{\text{AS}}=7\text{A}$, P-CH $I_{\text{AS}}=11\text{A}$, $R_{\text{G}}=25\Omega$, Starting $T_J=25^\circ\text{C}$.
- The data tested by pulsed, pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.
- Essentially independent of operating temperature.


Fig.1 Continuous Drain Current vs. T_J

Fig.2 Normalized RDSON vs. T_J

Fig.3 Normalized V_{th} vs. T_J

Fig.4 Gate Charge Waveform

Fig.5 Typical Output Characteristics

Fig.6 Turn-On Resistance vs. ID


Fig.7 Capacitance Characteristics

Fig.8 Normalized Transient Impedance

Fig.9 Maximum Safe Operation Area

P-CH Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise)
Off Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_D=-250\mu\text{A}$	-100	---	---	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	BV_{DSS} Temperature Coefficient	Reference to 25°C , $I_D=-1\text{mA}$	---	-0.06	---	$\text{V}/^\circ\text{C}$
I_{DSS}	Drain-Source Leakage Current	$V_{\text{DS}}=-100\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=25^\circ\text{C}$	---	---	-1	μA
		$V_{\text{DS}}=-80\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=125^\circ\text{C}$	---	---	-10	μA
I_{GSS}	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA

On Characteristics

$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=-10\text{V}$, $I_D=-1.5\text{A}$	---	240	290	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}$, $I_D=-1\text{A}$	---	260	340	$\text{m}\Omega$
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$, $I_D = -250\mu\text{A}$	-1.2	-1.6	-2.5	V
$\Delta V_{\text{GS(th)}}$	$V_{\text{GS(th)}}$ Temperature Coefficient		---	-4.4	---	$\text{mV}/^\circ\text{C}$
g_{fs}	Forward Transconductance	$V_{\text{DS}}=-10\text{V}$, $I_D=-1\text{A}$	---	5	---	S

Dynamic and switching Characteristics

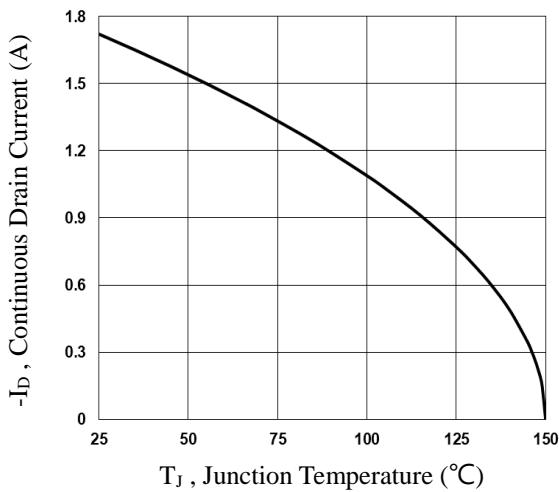
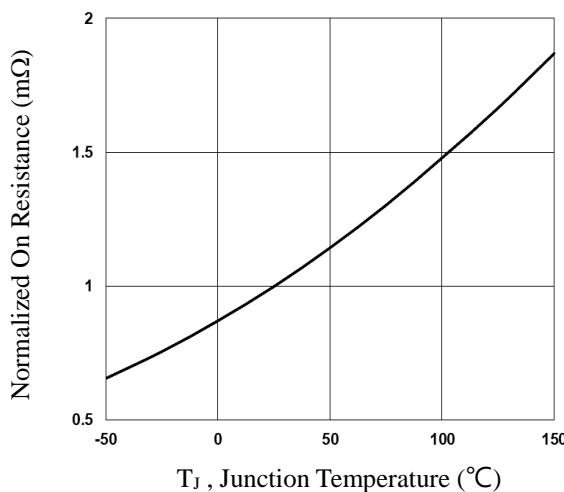
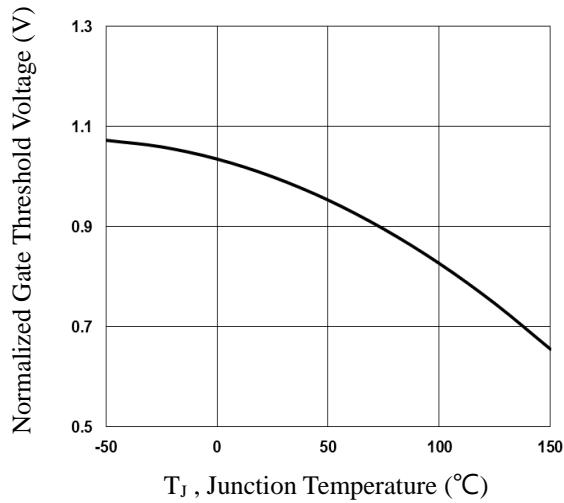
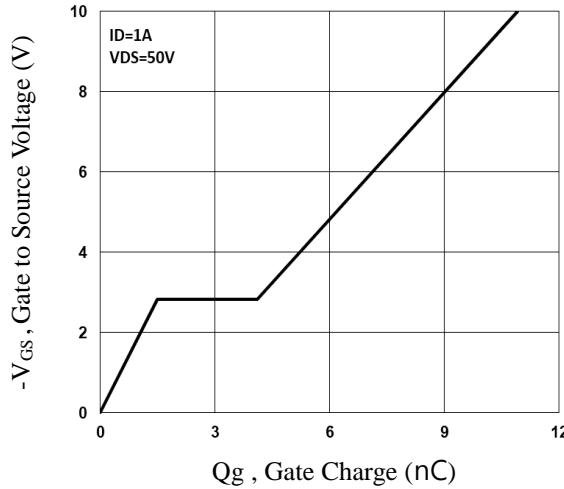
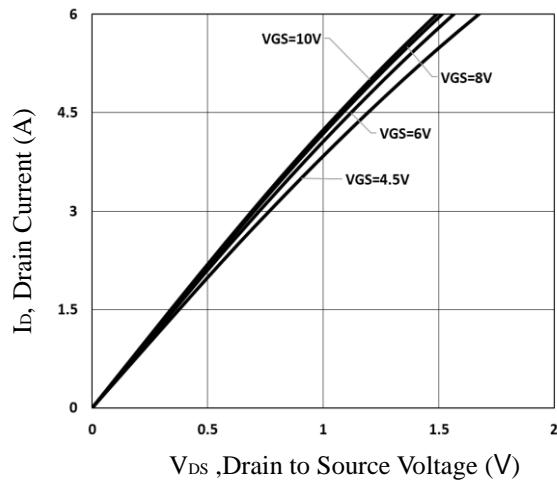
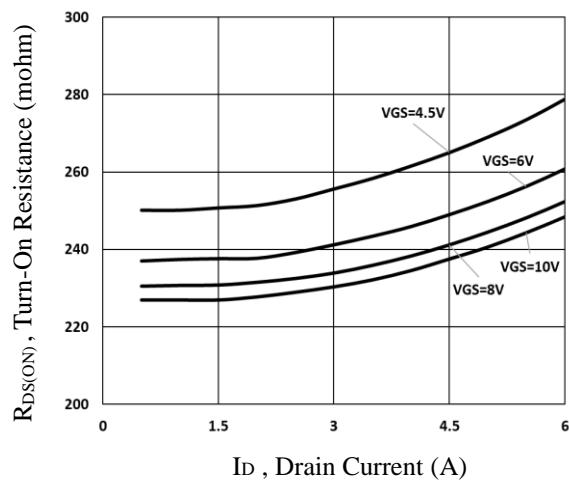
Q_g	Total Gate Charge ^{2, 3}	$V_{\text{DS}}=-50\text{V}$, $V_{\text{GS}}=-10\text{V}$, $I_D=-1\text{A}$	---	10.9	22	nC
Q_{gs}	Gate-Source Charge ^{2, 3}		---	1.5	3	
Q_{gd}	Gate-Drain Charge ^{2, 3}		---	2.6	5.2	
$T_{\text{d(on)}}$	Turn-On Delay Time ^{2, 3}	$V_{\text{DD}}=-50\text{V}$, $V_{\text{GS}}=-10\text{V}$, $R_G=6\Omega$	---	11.6	23	ns
T_r	Rise Time ^{2, 3}		---	4.8	10	
$T_{\text{d(off)}}$	Turn-Off Delay Time ^{2, 3}		---	35.8	72	
T_f	Fall Time ^{2, 3}		---	18.8	38	
C_{iss}	Input Capacitance	$V_{\text{DS}}=-50\text{V}$, $V_{\text{GS}}=0\text{V}$, $F=1\text{MHz}$	---	783	1560	pF
C_{oss}	Output Capacitance		---	33	66	
C_{rss}	Reverse Transfer Capacitance		---	22	45	
R_g	Gate resistance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, $F=1\text{MHz}$	---	15	30	Ω

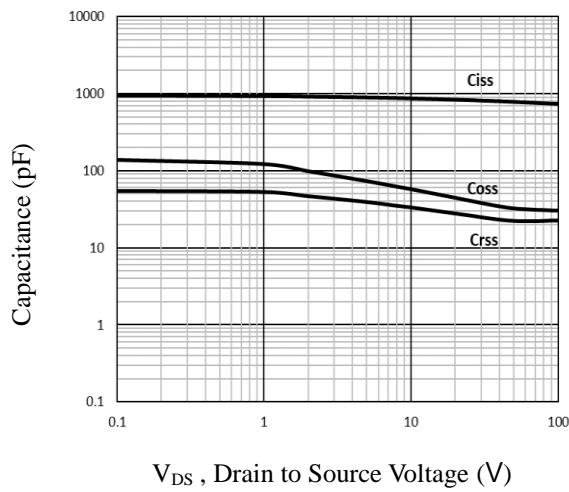
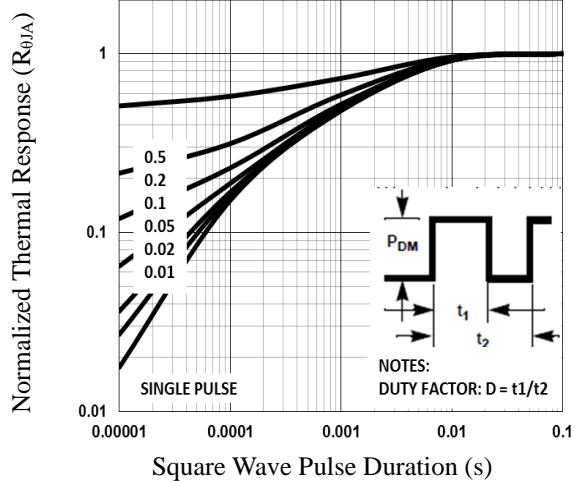
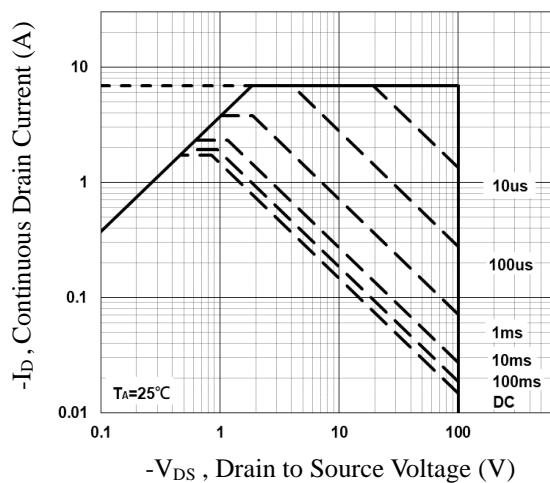
Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Continuous Source Current	$V_G=V_D=0\text{V}$, Force Current	---	---	-1.7	A
I_{SM}	Pulsed Source Current		---	---	-3.4	A
V_{SD}	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$, $I_s=-1\text{A}$, $T_J=25^\circ\text{C}$	---	---	-1	V

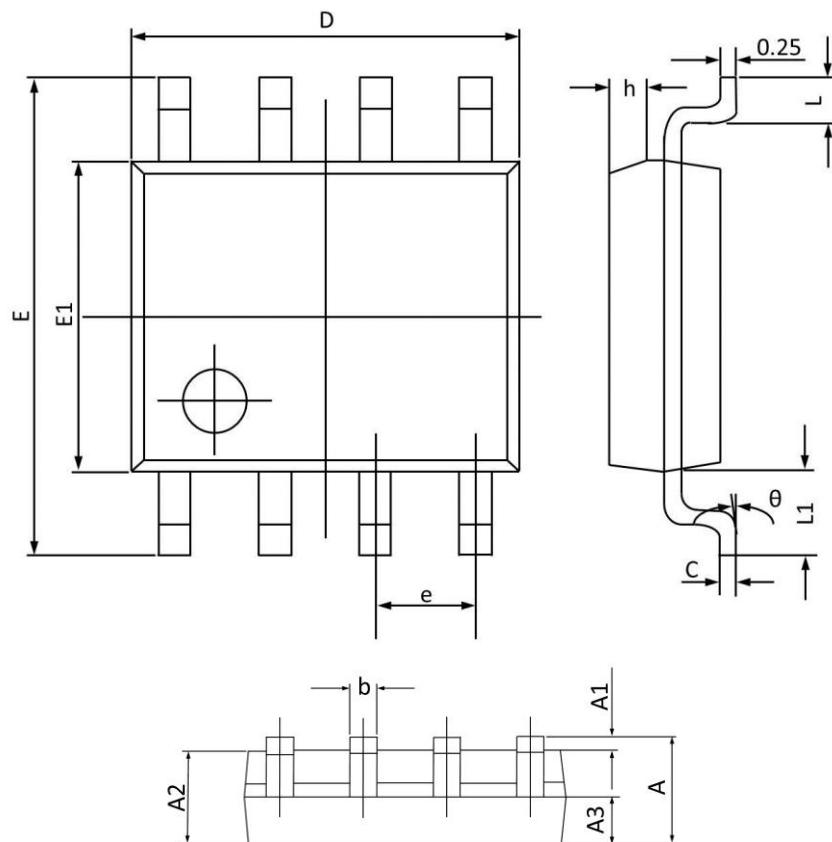
Note :

5. Repetitive Rating : Pulsed width limited by maximum junction temperature.
6. The data tested by pulsed, pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.
7. Essentially independent of operating temperature.


Fig.10 Continuous Drain Current vs. T_J

Fig.11 Normalized RDS(ON) vs. T_J

Fig.12 Normalized V_{th} vs. T_J

Fig.13 Gate Charge Waveform

Fig.14 Typical Output Characteristics

Fig.15 Turn-On Resistance vs. I_D


Fig.16 Capacitance Characteristics

Fig.17 Normalized Transient Impedance

Fig.18 Maximum Safe Operation Area

SOP-8L PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.068
A1	0.100	0.250	0.004	0.009
A2	1.300	1.500	0.052	0.059
A3	0.600	0.700	0.024	0.027
b	0.390	0.480	0.016	0.018
c	0.210	0.260	0.009	0.010
D	4.700	5.100	0.186	0.200
E	5.800	6.200	0.229	0.244
E1	3.700	4.100	0.146	0.161
e	1.270(BSC)		0.050(BSC)	
h	0.250	0.500	0.010	0.019
L	0.500	0.800	0.019	0.031
L1	1.050(BSC)		0.041(BSC)	
θ	0°	8°	0°	8°